# 5822134-3 ACTIVE

#### MICRO-EDGE

TE Internal #: 5822134-3

SIMM Sockets, 22° Module Orientation, 72 Position, Through Hole - Solder Mount, .05 in [1.27 mm] Centerline, 1 Row, Printed Circuit

Board, Signal

View on TE.com >



Connectors > Socket Connectors > Memory Sockets > SIMM Sockets



Module Orientation: 22°
Number of Positions: 72

PCB Mounting Style: Through Hole - Solder

Centerline (Pitch): 1.27 mm [ .05 in ]

Number of Rows: 1

### **Features**

## **Product Type Features**

Center Post	With
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Socket
Profile	Low

## **Configuration Features**

Center Key	None
Number of Keys	1
Module Orientation	22°
Number of Positions	72
Number of Rows	1

## **Body Features**

Ejector Location	None
Latch Material	Stainless Steel



Retention Post Location	Center
Latch Plating Material	Nickel
Contact Features	
Socket Style	SIMM
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1 A
Contact Mating Area Plating Thickness	200 μίη
Socket Type	Memory Card
Contact Mating Area Plating Material	Tin
Termination Features	
Insertion Style	Cam-In
Termination Post Length	2.92 mm, 3.56 mm[.115 in][.14 in]
Mechanical Attachment	
Polarization	Left
PCB Mounting Style	Through Hole - Solder
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Center Retention Hole Diameter	1.63 mm[.064 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube



Packaging Quantity

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

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#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

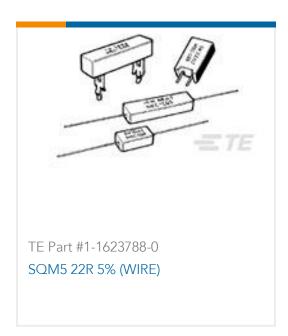
## Compatible Parts



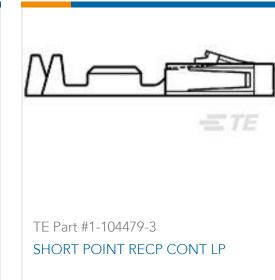
## Customers Also Bought

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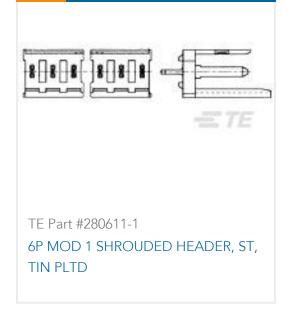




















### **Documents**

## **Product Drawings**

72 ME .050 L/P M/L PB-FREE

English

## **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5822134-3\_B\_c-5822134-3-b.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5822134-3\_B\_c-5822134-3-b.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5822134-3\_B\_c-5822134-3-b.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 



**Application Specification** 

English

MICRO-EDGE SIMM (Single In-Line Memory Module) Connectors

English

Product Environmental Compliance

TE Material Declaration

English